Unit: mm

TOSHIBA Field Effect Transistor Silicon N Channel MOS Type

# SSM3K15FS

# High Speed Switching Applications Analog Switching Applications

Compact package suitable for high-density mounting

• Low ON-resistance :  $R_{on} = 4.0 \Omega \text{ (max)} \text{ (@V}_{GS} = 4 \text{ V)}$ 

 $: R_{on} = 7.0 \ \Omega \ (max) \ (@V_{GS} = 2.5 \ V)$ 

# **Absolute Maximum Ratings (Ta = 25°C)**

Characteristic		Symbol	Rating	Unit	
Drain-Source voltage		$V_{DS}$	30	V	
Gate-Source voltage		V <sub>GSS</sub>	±20	V	
Drain current	DC	I <sub>D</sub>	100	mA	
	Pulse	I <sub>DP</sub>	200		
Drain power dissipation (Ta = 25°C)		P <sub>D</sub>	100	mW	
Channel temperature		T <sub>ch</sub>	150	°C	
Storage temperature range		T <sub>stg</sub>	-55~150	°C	

Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

1. GATE
2. SOURCE
3. DRAIN

SSM

JEDEC

JEITA

TOSHIBA

2-2H1B

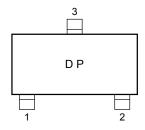
Weight: 2.4 mg (typ.)

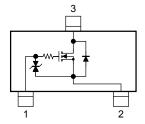
Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

### Marking

Note:

# **Equivalent Circuit**





#### **Handling Precaution**

When handling individual devices (which are not yet mounted on a circuit board), be sure that the environment is protected against electrostatic electricity. Operators should wear anti-static clothing, and containers and other objects that come into direct contact with devices should be made of anti-static materials.

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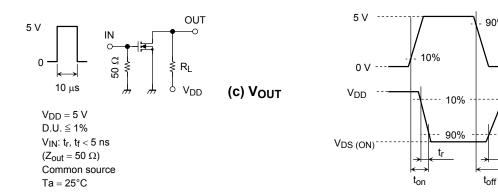
# **Electrical Characteristics (Ta = 25°C)**

Characteristic		Symbol	Test Condition	Min	Тур.	Max	Unit
Gate leakage current		I <sub>GSS</sub>	$V_{GS} = \pm 16 \text{ V}, V_{DS} = 0$	_	_	±1	μА
Drain-Source breakdown voltage		V (BR) DSS	$I_D = 0.1 \text{ mA}, V_{GS} = 0$	30	_	_	V
Drain Cut-off current		I <sub>DSS</sub>	$V_{DS} = 30 \text{ V}, V_{GS} = 0$	_	_	1	μА
Gate threshold voltage		$V_{th}$	$V_{DS} = 3 \text{ V}, I_D = 0.1 \text{ mA}$	0.8	_	1.5	V
Forward transfer admittance		Y <sub>fs</sub>	$V_{DS} = 3 \text{ V}, I_D = 10 \text{ mA}$	25	_	_	mS
Drain-Source ON resistance		R <sub>DS</sub> (ON)	$I_D = 10 \text{ mA}, V_{GS} = 4 \text{ V}$	_	2.2	4.0	Ω
			$I_D = 10 \text{ mA}, V_{GS} = 2.5 \text{ V}$	_	4.0	7.0	
Input capacitance		C <sub>iss</sub>	$V_{DS} = 3 \text{ V}, V_{GS} = 0, f = 1 \text{ MHz}$	_	7.8	_	pF
Reverse transfer capacitance		C <sub>rss</sub>	$V_{DS} = 3 \text{ V}, V_{GS} = 0, f = 1 \text{ MHz}$	_	3.6	_	pF
Output capacitance		Coss	$V_{DS} = 3 \text{ V}, V_{GS} = 0, f = 1 \text{ MHz}$	_	8.8	_	pF
Switching time	Turn-on time	t <sub>on</sub>	V <sub>DD</sub> = 5 V, I <sub>D</sub> = 10 mA, V <sub>GS</sub> = 0~5 V	_	50	_	ns
	Turn-off time	t <sub>off</sub>			180	_	

# **Switching Time Test Circuit**

(a) Test circuit

(b) V<sub>IN</sub>

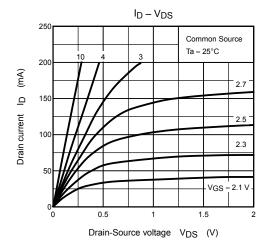


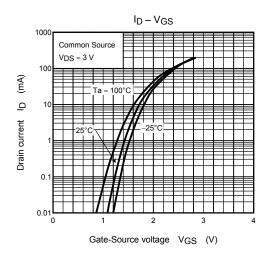
#### **Precaution**

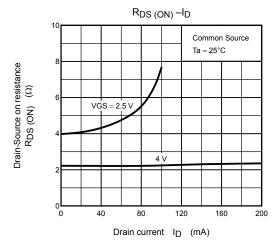
 $V_{th}$  can be expressed as voltage between gate and source when low operating current value is  $I_D$  = 100  $\mu A$  for this product. For normal switching operation,  $V_{GS}$  (on) requires higher voltage than  $V_{th}$  and  $V_{GS}$  (off) requires lower voltage than  $V_{th}$ .

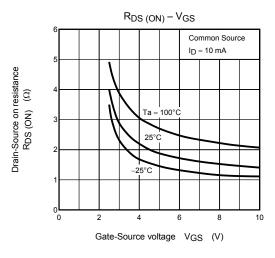
(relationship can be established as follows:  $V_{GS\ (off)} < V_{th} < V_{GS\ (on)}$  )

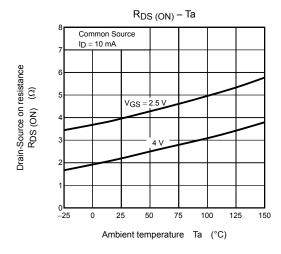
Please take this into consideration for using the device.

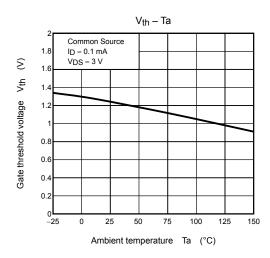




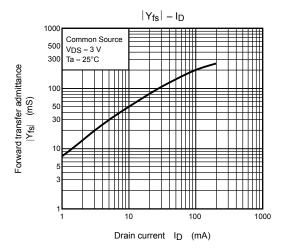


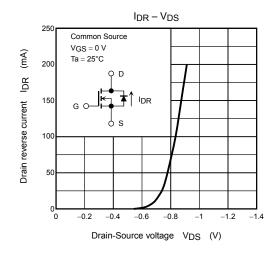


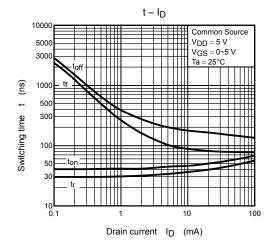


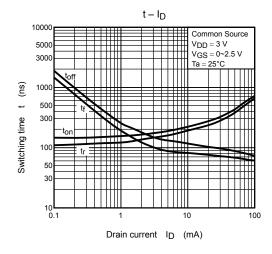


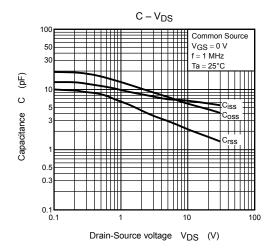
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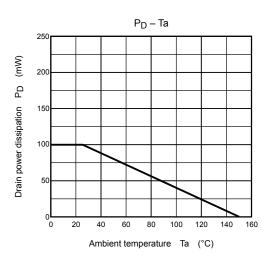












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